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Details

Product Status	Active
Core Processor	HCS12X
Core Size	16-Bit
Speed	50MHz
Connectivity	CANbus, EBI/EMI, I ² C, IrDA, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	59
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	12K x 8
Voltage - Supply (Vcc/Vdd)	1.72V ~ 5.5V
Data Converters	A/D 8x12b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	80-QFP
Supplier Device Package	80-QFP (14x14)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=s912xeg128j2maa



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Table 2-3. Pin Configuration Summary

DDR	IO	RDR	PE	PS ⁽¹⁾	IE ⁽²⁾	Function	Pull Device	Interrupt
0	x	x	0	x	0	Input	Disabled	Disabled
0	x	x	1	0	0	Input	Pull Up	Disabled
0	x	x	1	1	0	Input	Pull Down	Disabled
0	x	x	0	0	1	Input	Disabled	Falling edge
0	x	x	0	1	1	Input	Disabled	Rising edge
0	x	x	1	0	1	Input	Pull Up	Falling edge
0	x	x	1	1	1	Input	Pull Down	Rising edge
1	0	0	x	x	0	Output, full drive to 0	Disabled	Disabled
1	1	0	x	x	0	Output, full drive to 1	Disabled	Disabled
1	0	1	x	x	0	Output, reduced drive to 0	Disabled	Disabled
1	1	1	x	x	0	Output, reduced drive to 1	Disabled	Disabled
1	0	0	x	0	1	Output, full drive to 0	Disabled	Falling edge
1	1	0	x	1	1	Output, full drive to 1	Disabled	Rising edge
1	0	1	x	0	1	Output, reduced drive to 0	Disabled	Falling edge
1	1	1	x	1	1	Output, reduced drive to 1	Disabled	Rising edge

1. Always "0" on Port A, B, C, D, E, K, AD0, and AD1.

2. Applicable only on Port P, H, and J.

NOTE

All register bits in this module are completely synchronous to internal clocks during a register read.



This register controls input pin threshold level and determines the external address and data bus sizes in normal expanded mode. If not in use with the external bus interface, the related pins can be used for alternative functions.

External bus is available as programmed in normal expanded mode and always full-sized in emulation modes and special test mode; function not available in single-chip modes.

Table 5-3. EBICTL0 Field Descriptions

Field	Description
7 ITHRS	<p>Reduced Input Threshold — This bit selects reduced input threshold on external data bus pins and specific control input signals which are in use with the external bus interface in order to adapt to external devices with a 3.3 V, 5 V tolerant I/O.</p> <p>The reduced input threshold level takes effect depending on ITHRS, the operating mode and the related enable signals of the EBI pin function as summarized in Table 5-4.</p> <p>0 Input threshold is at standard level on all pins 1 Reduced input threshold level enabled on pins in use with the external bus interface</p>
5 HDBE	<p>High Data Byte Enable — This bit enables the higher half of the 16-bit data bus. If disabled, only the lower 8-bit data bus can be used with the external bus interface. In this case the unused data pins and the data select signals (\overline{UDS} and \overline{LDS}) are free to be used for alternative functions.</p> <p>0 DATA[15:8], \overline{UDS}, and \overline{LDS} disabled 1 DATA[15:8], \overline{UDS}, and \overline{LDS} enabled</p>
4–0 ASIZ[4:0]	<p>External Address Bus Size — These bits allow scalability of the external address bus. The programmed value corresponds to the number of available low-aligned address lines (refer to Table 5-5). All address lines ADDR[22:0] start up as outputs after reset in expanded modes. This needs to be taken into consideration when using alternative functions on relevant pins in applications which utilize a reduced external address bus.</p>

Table 5-4. Input Threshold Levels on External Signals

ITHRS	External Signal	NS	SS	NX	ES	EX	ST
0	DATA[15:8] \overline{TAGHI} , \overline{TAGLO}	Standard	Standard	Standard	Reduced	Reduced	Standard
	DATA[7:0]				Standard	Standard	
	\overline{EWAIT}				Standard	Standard	
1	DATA[15:8] \overline{TAGHI} , \overline{TAGLO}	Standard	Standard	Reduced if HDBE = 1	Reduced	Reduced	Reduced
	DATA[7:0]			Reduced	Reduced	Reduced	
	\overline{EWAIT}			Reduced if \overline{EWAIT} enabled ⁽¹⁾	Standard	Reduced if \overline{EWAIT} enabled ¹	Standard

1. \overline{EWAIT} function is enabled if at least one CSx line is configured respectively in MMCC1L0. Refer to S12X_MMC section and Table 5-6.

Table 5-5. External Address Bus Size

ASIZ[4:0]	Available External Address Lines
00000	None
00001	\overline{UDS}
00010	ADDR1, \overline{UDS}

state operation (stretching) of the external bus access is done in emulation modes when accessing internal memory or emulation memory addresses.

In both modes observation of the internal operation is supported through the external bus (internal visibility).

5.5.2.1 Example 2a: Emulation Single-Chip Mode

This mode is used for emulation systems in which the target application is operating in normal single-chip mode.

Figure 5-5 shows the PRU connection with the available external bus signals in an emulator application.

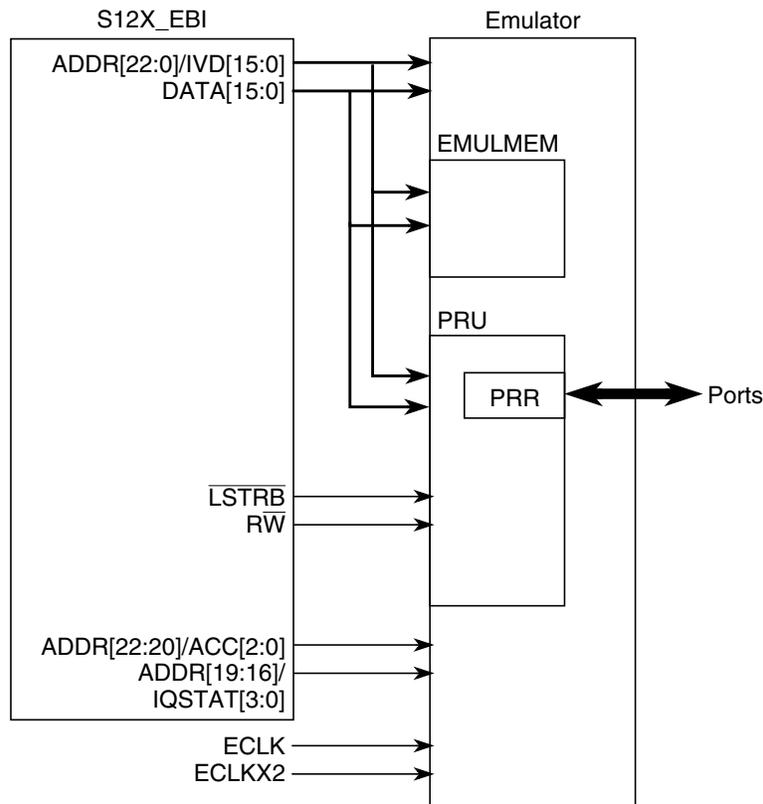


Figure 5-5. Application in Emulation Single-Chip Mode

The timing diagram for this operation is shown in:

- Figure ‘Example 2a: Emulation Single-Chip Mode — Read Followed by Write’

The associated timing numbers are given in:

- Table ‘Example 2a: Emulation Single-Chip Mode Timing (EWAIT disabled)’

Timing considerations:

- Signals muxed with address lines ADDR_x, i.e., IVD_x, IQSTAT_x and ACC_x, have the same timing.
- $\overline{\text{LSTRB}}$ has the same timing as $\overline{\text{RW}}$.

8.4.7.1 XGATE Software Breakpoints

The XGATE software breakpoint instruction BRK can request a CPU12X breakpoint, via the S12XDBG module. In this case, if the XGSBPE bit is set, the S12XDBG module immediately generates a forced breakpoint request to the CPU12X, the state sequencer is returned to state0 and tracing, if active, is terminated. If configured for BEGIN trigger and tracing has not yet been triggered from another source, the trace buffer contains no information. Breakpoint requests from the XGATE module do not depend upon the state of the DBGBRK or ARM bits in DBGCR1. They depend solely on the state of the XGSBPE and BDM bits. Thus it is not necessary to ARM the DBG module to use XGATE software breakpoints to generate breakpoints in the CPU12X program flow, but it is necessary to set XGSBPE. Furthermore, if a breakpoint to BDM is required, the BDM bit must also be set. When the XGATE requests an CPU12X breakpoint, the XGATE program flow stops by default, independent of the S12XDBG module.

8.4.7.2 Breakpoints From Internal Comparator Channel Final State Triggers

Breakpoints can be generated when internal comparator channels trigger the state sequencer to the Final State. If configured for tagging, then the breakpoint is generated when the tagged opcode reaches the execution stage of the instruction queue.

If a tracing session is selected by TSOURCE, breakpoints are requested when the tracing session has completed, thus if Begin or Mid aligned triggering is selected, the breakpoint is requested only on completion of the subsequent trace (see [Table 8-48](#)). If no tracing session is selected, breakpoints are requested immediately.

If the BRK bit is set on the triggering channel, then the breakpoint is generated immediately independent of tracing trigger alignment.

Table 8-48. Breakpoint Setup For Both XGATE and CPU12X Breakpoints

BRK	TALIGN	DBGBRK[n]	Breakpoint Alignment
0	00	0	Fill Trace Buffer until trigger (no breakpoints — keep running)
0	00	1	Fill Trace Buffer until trigger, then breakpoint request occurs
0	01	0	Start Trace Buffer at trigger (no breakpoints — keep running)
0	01	1	Start Trace Buffer at trigger A breakpoint request occurs when Trace Buffer is full
0	10	0	Store a further 32 Trace Buffer line entries after trigger (no breakpoints — keep running)
0	10	1	Store a further 32 Trace Buffer line entries after trigger Request breakpoint after the 32 further Trace Buffer entries
1	00,01,10	1	Terminate tracing and generate breakpoint immediately on trigger
1	00,01,10	0	Terminate tracing immediately on trigger
x	11	x	Reserved

		127	126	125	124	123	122	121	120	119	118	117	116	115	114	113	112
0x0008 XGIF	R	0	0	0	0	0	0	0	XGIF_78	XGF_77	XGIF_76	XGIF_75	XGIF_74	XGIF_73	XGIF_72	XGIF_71	XGIF_70
	W																
		111	110	109	108	107	106	105	104	103	102	101	100	99	98	97	96
0x000A XGIF	R	XGIF_6F	XGIF_6E	XGIF_6D	XGIF_6C	XGIF_6B	XGIF_6A	XGIF_69	XGIF_68	XGF_67	XGIF_66	XGIF_65	XGIF_64	XGIF_63	XGIF_62	XGIF_61	XGIF_60
	W																
		95	94	93	92	91	90	89	88	87	86	85	84	83	82	81	80
0x000C XGIF	R	XGIF_5F	XGIF_5E	XGIF_5D	XGIF_5C	XGIF_5B	XGIF_5A	XGIF_59	XGIF_58	XGF_57	XGIF_56	XGIF_55	XGIF_54	XGIF_53	XGIF_52	XGIF_51	XGIF_50
	W																
		79	78	77	76	75	74	73	72	71	70	69	68	67	66	65	64
0x000E XGIF	R	XGIF_4F	XGIF_4E	XGIF_4D	XGIF_4C	XGIF_4B	XGIF_4A	XGIF_49	XGIF_48	XGF_47	XGIF_46	XGIF_45	XGIF_44	XGIF_43	XGIF_42	XGIF_41	XGIF_40
	W																
		63	62	61	60	59	58	57	56	55	54	53	52	51	50	49	48
0x0010 XGIF	R	XGIF_3F	XGIF_3E	XGIF_3D	XGIF_3C	XGIF_3B	XGIF_3A	XGIF_39	XGIF_38	XGF_37	XGIF_36	XGIF_35	XGIF_34	XGIF_33	XGIF_32	XGIF_31	XGIF_30
	W																
		47	46	45	44	43	42	41	40	39	38	37	36	35	34	33	32
0x0012 XGIF	R	XGIF_2F	XGIF_2E	XGIF_2D	XGIF_2C	XGIF_2B	XGIF_2A	XGIF_29	XGIF_28	XGF_27	XGIF_26	XGIF_25	XGIF_24	XGIF_23	XGIF_22	XGIF_21	XGIF_20
	W																
		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
0x0014 XGIF	R	XGIF_1F	XGIF_1E	XGIF_1D	XGIF_1C	XGIF_1B	XGIF_1A	XGIF_19	XGIF_18	XGF_17	XGIF_16	XGIF_15	XGIF_14	XGIF_13	XGIF_12	XGIF_11	XGIF_10
	W																
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0x0016 XGIF	R	XGIF_0F	XGIF_0E	XGIF_0D	0	0	0	0	0	0	0	0	0	0	0	0	0
	W																

= Unimplemented or Reserved

Figure 10-2. XGATE Register Summary (Sheet 2 of 3)

10.3.1.14 XGATE Register 2 (XGR2)

The XGR2 register (Figure 10-16) provides access to the RISC core’s register 2.

Module Base +0x00024

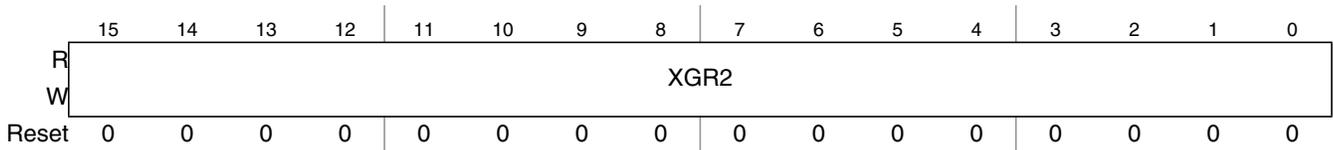


Figure 10-16. XGATE Register 2 (XGR2)

Read: In debug mode if unsecured and not idle (XGCHID ≠ 0x00)

Write: In debug mode if unsecured and not idle (XGCHID ≠ 0x00)

Table 10-16. XGR2 Field Descriptions

Field	Description
15–0 XGR2[15:0]	XGATE Register 2 — The RISC core’s register 2

10.3.1.15 XGATE Register 3 (XGR3)

The XGR3 register (Figure 10-17) provides access to the RISC core’s register 3.

Module Base +0x00026

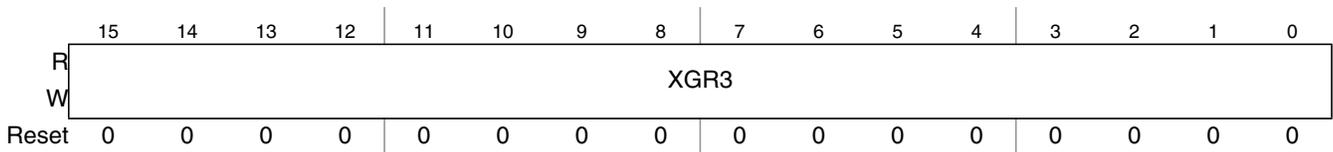


Figure 10-17. XGATE Register 3 (XGR3)

Read: In debug mode if unsecured and not idle (XGCHID ≠ 0x00)

Write: In debug mode if unsecured and not idle (XGCHID ≠ 0x00)

Table 10-17. XGR3 Field Descriptions

Field	Description
15–0 XGR3[15:0]	XGATE Register 3 — The RISC core’s register 3

13.3.2.12 ATD Conversion Result Registers (ATDDR n)

The A/D conversion results are stored in 16 result registers. Results are always in unsigned data representation. Left and right justification is selected using the DJM control bit in ATDCTL3.

If automatic compare of conversions results is enabled (CMPE[n]=1 in ATDCMPE), these registers must be written with the compare values in left or right justified format depending on the actual value of the DJM bit. In this case, as the ATDDR n register is used to hold the compare value, the result will not be stored there at the end of the conversion but is lost.

Read: Anytime

Write: Anytime

NOTE

For conversions not using automatic compare, results are stored in the result registers after each conversion. In this case avoid writing to ATDDR n except for initial values, because an A/D result might be overwritten.

13.3.2.12.1 Left Justified Result Data (DJM=0)

Module Base +

0x0010 = ATDDR0, 0x0012 = ATDDR1, 0x0014 = ATDDR2, 0x0016 = ATDDR3

0x0018 = ATDDR4, 0x001A = ATDDR5, 0x001C = ATDDR6, 0x001E = ATDDR7

0x0020 = ATDDR8, 0x0022 = ATDDR9, 0x0024 = ATDDR10, 0x0026 = ATDDR11

0x0028 = ATDDR12, 0x002A = ATDDR13, 0x002C = ATDDR14, 0x002E = ATDDR15

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	0	0	0	0
W																
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Figure 13-14. Left justified ATD conversion result register (ATDDR n)

13.3.2.12.2 Right Justified Result Data (DJM=1)

Module Base +

0x0010 = ATDDR0, 0x0012 = ATDDR1, 0x0014 = ATDDR2, 0x0016 = ATDDR3

0x0018 = ATDDR4, 0x001A = ATDDR5, 0x001C = ATDDR6, 0x001E = ATDDR7

0x0020 = ATDDR8, 0x0022 = ATDDR9, 0x0024 = ATDDR10, 0x0026 = ATDDR11

0x0028 = ATDDR12, 0x002A = ATDDR13, 0x002C = ATDDR14, 0x002E = ATDDR15

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	0	0	0	0	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
W																
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Figure 13-15. Right justified ATD conversion result register (ATDDR n)

Table 13-16 shows how depending on the A/D resolution the conversion result is transferred to the ATD result registers. Compare is always done using all 12 bits of both the conversion result and the compare value in ATDDR n .

software simpler because only one address area is applicable for the transmit process, and the required address space is minimized.

The CPU then stores the identifier, the control bits, and the data content into one of the transmit buffers. Finally, the buffer is flagged as ready for transmission by clearing the associated TXE flag.

The MSCAN then schedules the message for transmission and signals the successful transmission of the buffer by setting the associated TXE flag. A transmit interrupt (see [Section 16.4.7.2, “Transmit Interrupt”](#)) is generated¹ when TXEx is set and can be used to drive the application software to re-load the buffer.

If more than one buffer is scheduled for transmission when the CAN bus becomes available for arbitration, the MSCAN uses the local priority setting of the three buffers to determine the prioritization. For this purpose, every transmit buffer has an 8-bit local priority field (PRIO). The application software programs this field when the message is set up. The local priority reflects the priority of this particular message relative to the set of messages being transmitted from this node. The lowest binary value of the PRIO field is defined to be the highest priority. The internal scheduling process takes place whenever the MSCAN arbitrates for the CAN bus. This is also the case after the occurrence of a transmission error.

When a high priority message is scheduled by the application software, it may become necessary to abort a lower priority message in one of the three transmit buffers. Because messages that are already in transmission cannot be aborted, the user must request the abort by setting the corresponding abort request bit (ABTRQ) (see [Section 16.3.2.9, “MSCAN Transmitter Message Abort Request Register \(CANTARQ\)”](#).) The MSCAN then grants the request, if possible, by:

1. Setting the corresponding abort acknowledge flag (ABTAK) in the CANTAACK register.
2. Setting the associated TXE flag to release the buffer.
3. Generating a transmit interrupt. The transmit interrupt handler software can determine from the setting of the ABTAK flag whether the message was aborted (ABTAK = 1) or sent (ABTAK = 0).

16.4.2.3 Receive Structures

The received messages are stored in a five stage input FIFO. The five message buffers are alternately mapped into a single memory area (see [Figure 16-39](#)). The background receive buffer (RxBG) is exclusively associated with the MSCAN, but the foreground receive buffer (RxFG) is addressable by the CPU (see [Figure 16-39](#)). This scheme simplifies the handler software because only one address area is applicable for the receive process.

All receive buffers have a size of 15 bytes to store the CAN control bits, the identifier (standard or extended), the data contents, and a time stamp, if enabled (see [Section 16.3.3, “Programmer’s Model of Message Storage”](#)).

The receiver full flag (RXF) (see [Section 16.3.2.5, “MSCAN Receiver Flag Register \(CANRFLG\)”](#)) signals the status of the foreground receive buffer. When the buffer contains a correctly received message with a matching identifier, this flag is set.

On reception, each message is checked to see whether it passes the filter (see [Section 16.4.3, “Identifier Acceptance Filter”](#)) and simultaneously is written into the active RxBG. After successful reception of a valid message, the MSCAN shifts the content of RxBG into the receiver FIFO, sets the RXF flag, and

1. The transmit interrupt occurs only if not masked. A polling scheme can be applied on TXEx also.

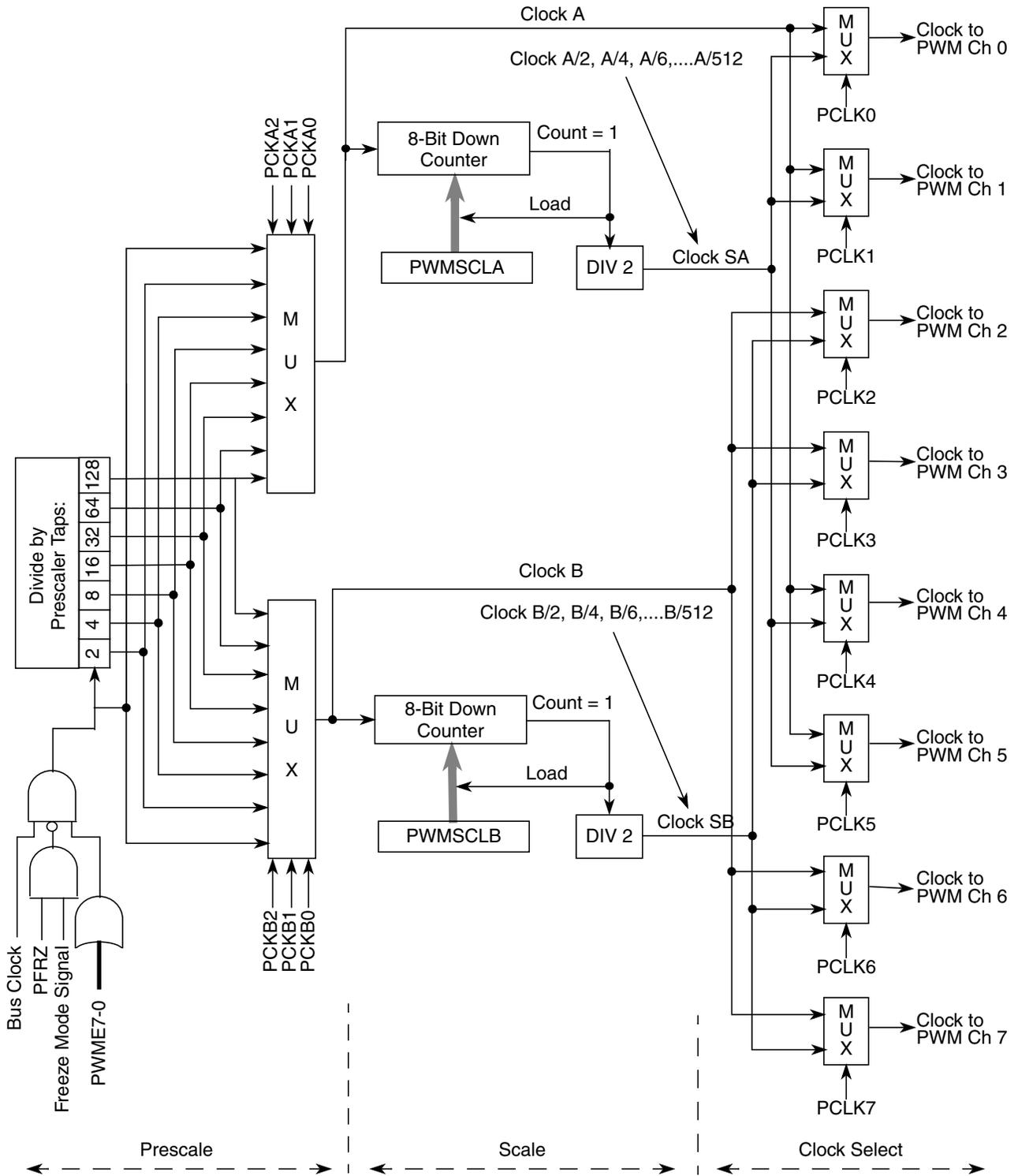


Figure 19-18. PWM Clock Select Block Diagram

On the front end of the PWM timer, the clock is enabled to the PWM circuit by the PWME_x bit being high. There is an edge-synchronizing circuit to guarantee that the clock will only be enabled or disabled at an edge. When the channel is disabled (PWME_x = 0), the counter for the channel does not count.

19.4.2.2 PWM Polarity

Each channel has a polarity bit to allow starting a waveform cycle with a high or low signal. This is shown on the block diagram as a mux select of either the Q output or the \bar{Q} output of the PWM output flip flop. When one of the bits in the PWMPOL register is set, the associated PWM channel output is high at the beginning of the waveform, then goes low when the duty count is reached. Conversely, if the polarity bit is zero, the output starts low and then goes high when the duty count is reached.

19.4.2.3 PWM Period and Duty

Dedicated period and duty registers exist for each channel and are double buffered so that if they change while the channel is enabled, the change will NOT take effect until one of the following occurs:

- The effective period ends
- The counter is written (counter resets to \$00)
- The channel is disabled

In this way, the output of the PWM will always be either the old waveform or the new waveform, not some variation in between. If the channel is not enabled, then writes to the period and duty registers will go directly to the latches as well as the buffer.

A change in duty or period can be forced into effect “immediately” by writing the new value to the duty and/or period registers and then writing to the counter. This forces the counter to reset and the new duty and/or period values to be latched. In addition, since the counter is readable, it is possible to know where the count is with respect to the duty value and software can be used to make adjustments

NOTE

When forcing a new period or duty into effect immediately, an irregular PWM cycle can occur.

Depending on the polarity bit, the duty registers will contain the count of either the high time or the low time.

19.4.2.4 PWM Timer Counters

Each channel has a dedicated 8-bit up/down counter which runs at the rate of the selected clock source (see Section 19.4.1, “PWM Clock Select” for the available clock sources and rates). The counter compares to two registers, a duty register and a period register as shown in Figure 19-19. When the PWM counter matches the duty register, the output flip-flop changes state, causing the PWM waveform to also change state. A match between the PWM counter and the period register behaves differently depending on what output mode is selected as shown in Figure 19-19 and described in Section 19.4.2.5, “Left Aligned Outputs” and Section 19.4.2.6, “Center Aligned Outputs”.

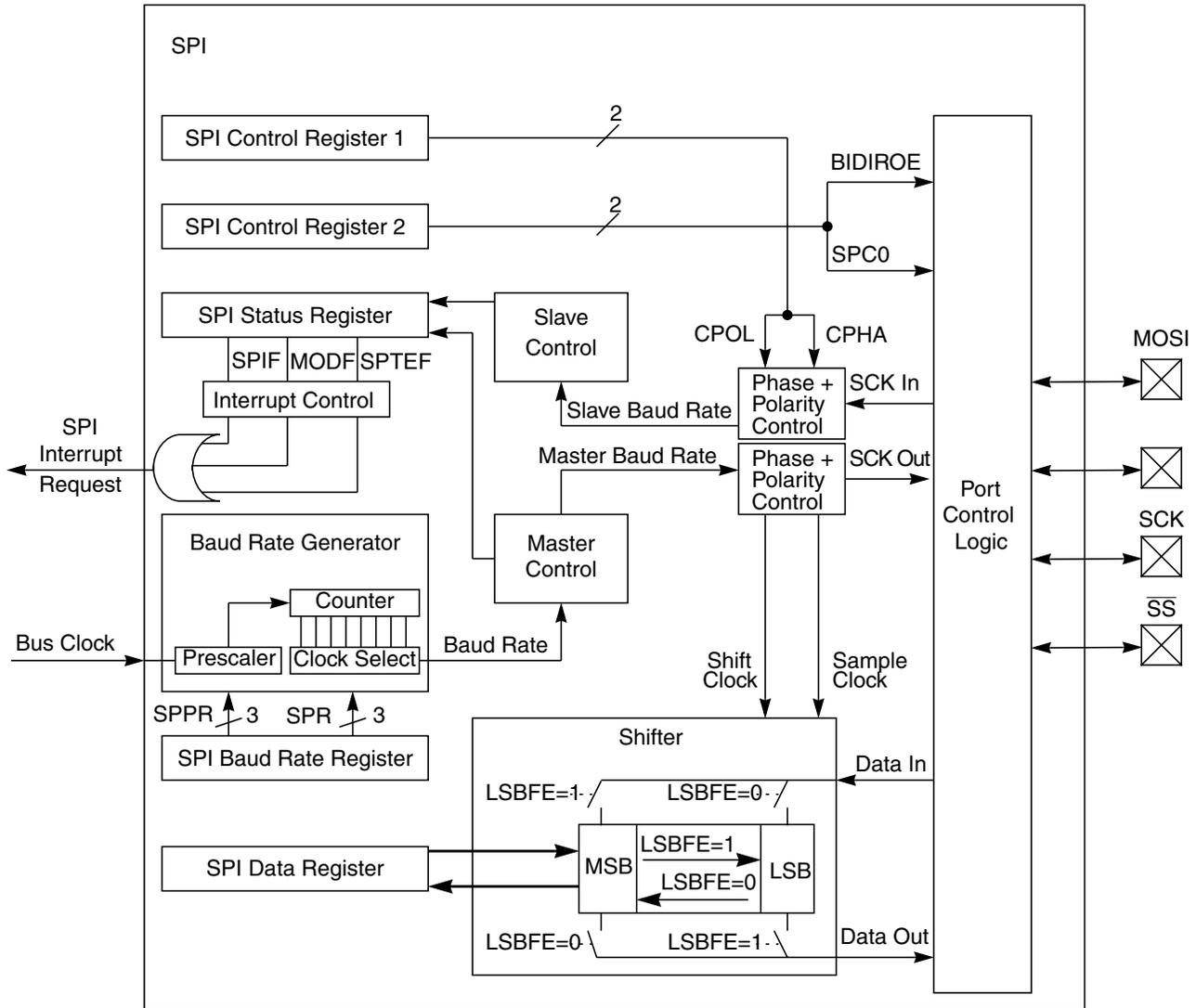


Figure 21-1. SPI Block Diagram

21.2 External Signal Description

This section lists the name and description of all ports including inputs and outputs that do, or may, connect off chip. The SPI module has a total of four external pins.

21.2.1 MOSI — Master Out/Slave In Pin

This pin is used to transmit data out of the SPI module when it is configured as a master and receive data when it is configured as slave.

21.2.2 MISO — Master In/Slave Out Pin

This pin is used to transmit data out of the SPI module when it is configured as a slave and receive data when it is configured as master.

22.2.7 IOC1 — Input Capture and Output Compare Channel 1 Pin

This pin serves as input capture or output compare for channel 1.

22.2.8 IOC0 — Input Capture and Output Compare Channel 0 Pin

This pin serves as input capture or output compare for channel 0.

NOTE

For the description of interrupts see [Section 22.6, “Interrupts”](#).

22.3 Memory Map and Register Definition

This section provides a detailed description of all memory and registers.

22.3.1 Module Memory Map

The memory map for the TIM16B8CV2 module is given below in [Figure 22-5](#). The address listed for each register is the address offset. The total address for each register is the sum of the base address for the TIM16B8CV2 module and the address offset for each register.

22.3.2 Register Descriptions

This section consists of register descriptions in address order. Each description includes a standard register diagram with an associated figure number. Details of register bit and field function follow the register diagrams, in bit order.

Register Name		Bit 7	6	5	4	3	2	1	Bit 0
0x0000 TIOS	R W	IOS7	IOS6	IOS5	IOS4	IOS3	IOS2	IOS1	IOS0
0x0001 CFORC	R W	0 FOC7	0 FOC6	0 FOC5	0 FOC4	0 FOC3	0 FOC2	0 FOC1	0 FOC0
0x0002 OC7M	R W	OC7M7	OC7M6	OC7M5	OC7M4	OC7M3	OC7M2	OC7M1	OC7M0
0x0003 OC7D	R W	OC7D7	OC7D6	OC7D5	OC7D4	OC7D3	OC7D2	OC7D1	OC7D0
0x0004 TCNTH	R W	TCNT15	TCNT14	TCNT13	TCNT12	TCNT11	TCNT10	TCNT9	TCNT8
0x0005 TCNTL	R W	TCNT7	TCNT6	TCNT5	TCNT4	TCNT3	TCNT2	TCNT1	TCNT0

= Unimplemented or Reserved

Figure 22-5. TIM16B8CV2 Register Summary (Sheet 1 of 3)

Table 23-13. Interrupt Vectors

Interrupt Source	Local Enable
Low-voltage interrupt (LVI)	LVIE = 1; available only in Full Performance Mode
High Temperature Interrupt (HTI)	HTIE=1; available only in Full Performance Mode
Autonomous periodical interrupt (API)	APIE = 1

23.4.11.1 Low-Voltage Interrupt (LVI)

In FPM, VREG_3V3 monitors the input voltage V_{DDA} . Whenever V_{DDA} drops below level V_{LVIA} , the status bit LVDS is set to 1. On the other hand, LVDS is reset to 0 when V_{DDA} rises above level V_{LVID} . An interrupt, indicated by flag LVIF = 1, is triggered by any change of the status bit LVDS if interrupt enable bit LVIE = 1.

NOTE

On entering the Reduced Power Mode, the LVIF is not cleared by the VREG_3V3.

23.4.11.2 HTI - High Temperature Interrupt

In FPM VREG monitors the die temperature T_{DIE} . Whenever T_{DIE} exceeds level T_{HTIA} the status bit HTDS is set to 1. Vice versa, HTDS is reset to 0 when T_{DIE} get below level T_{HTID} . An interrupt, indicated by flag HTIF=1, is triggered by any change of the status bit HTDS if interrupt enable bit HTIE=1.

NOTE

On entering the Reduced Power Mode the HTIF is not cleared by the VREG.

23.4.11.3 Autonomous Periodical Interrupt (API)

As soon as the configured timeout period of the API has elapsed, the APIF bit is set. An interrupt, indicated by flag APIF = 1, is triggered if interrupt enable bit APIE = 1.

Table 24-3. Flash Configuration Field⁽¹⁾

Global Address	Size (Bytes)	Description
0x7F_FF0F ²	1	Flash Security byte Refer to Section 24.3.2.2 , “Flash Security Register (FSEC)”

1. Older versions may have swapped protection byte addresses

2. 0x7FF08 - 0x7F_FF0F form a Flash phrase and must be programmed in a single command write sequence. Each byte in the 0x7F_FF08 - 0x7F_FF0B reserved field should be programmed to 0xFF.

Table 25-47. Erase All Blocks Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters	
000	0x08	Not required

Upon clearing CCIF to launch the Erase All Blocks command, the Memory Controller will erase the entire Flash memory space and verify that it is erased. If the Memory Controller verifies that the entire Flash memory space was properly erased, security will be released. During the execution of this command (CCIF=0) the user must not write to any Flash module register. The CCIF flag will set after the Erase All Blocks operation has completed.

Table 25-48. Erase All Blocks Command Error Handling

Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] != 000 at command launch
		Set if a Load Data Field command sequence is currently active
		Set if command not available in current mode (see Table 25-30)
	FPVIOL	Set if any area of the P-Flash memory is protected
	MGSTAT1	Set if any errors have been encountered during the verify operation
	MGSTAT0	Set if any non-correctable errors have been encountered during the verify operation
FERSTAT	EPVIOLIF	Set if any area of the buffer RAM EEE partition is protected

25.4.2.9 Erase P-Flash Block Command

The Erase P-Flash Block operation will erase all addresses in a P-Flash block.

Table 25-49. Erase P-Flash Block Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters	
000	0x09	Global address [22:16] to identify P-Flash block
001	Global address [15:0] in P-Flash block to be erased	

Upon clearing CCIF to launch the Erase P-Flash Block command, the Memory Controller will erase the selected P-Flash block and verify that it is erased. The CCIF flag will set after the Erase P-Flash Block operation has completed.

Table 28-76. EEPROM Emulation Query Command Error Handling

Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] != 000 at command launch
		Set if a Load Data Field command sequence is currently active
		Set if command not available in current mode (see Table 28-30)
	FPVIOL	None
	MGSTAT1	None
	MGSTAT0	None
FERSTAT	EPVIOLIF	None

28.4.2.22 Partition D-Flash Command

The Partition D-Flash command allows the user to allocate sectors within the D-Flash block for applications and a partition within the buffer RAM for EEPROM access. The D-Flash block consists of 128 sectors with 256 bytes per sector. The Erase All Blocks command must be run prior to launching the Partition D-Flash command.

Table 28-77. Partition D-Flash Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters	
000	0x20	Not required
001	Number of 256 byte sectors for the D-Flash user partition (DFPART)	
010	Number of 256 byte sectors for buffer RAM EEE partition (ERPART)	

Upon clearing CCIF to launch the Partition D-Flash command, the following actions are taken to define a partition within the D-Flash block for direct access (DFPART) and a partition within the buffer RAM for EEE use (ERPART):

- Validate the DFPART and ERPART values provided:
 - DFPART \leq 128 (maximum number of 256 byte sectors in D-Flash block)
 - ERPART \leq 16 (maximum number of 256 byte sectors in buffer RAM)
 - If ERPART $>$ 0, $128 - \text{DFPART} \geq 12$ (minimum number of 256 byte sectors in the D-Flash block required to support EEE)
 - If ERPART $>$ 0, $((128 - \text{DFPART}) / \text{ERPART}) \geq 8$ (minimum ratio of D-Flash EEE space to buffer RAM EEE space to support EEE)
- Erase verify the D-Flash block and the EEE nonvolatile information register
- Program DFPART to the EEE nonvolatile information register at global address 0x12_0000 (see Table 28-7)

2. FDIV shown generates an FCLK frequency of 1.05 MHz

29.3.2.2 Flash Security Register (FSEC)

The FSEC register holds all bits associated with the security of the MCU and Flash module.

Offset Module Base + 0x0001

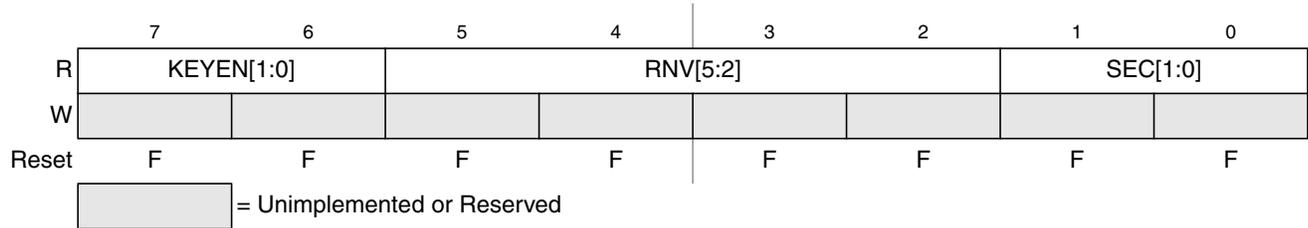


Figure 29-6. Flash Security Register (FSEC)

All bits in the FSEC register are readable but not writable.

During the reset sequence, the FSEC register is loaded with the contents of the Flash security byte in the Flash configuration field at global address 0x7F_FF0F located in P-Flash memory (see Table 29-3) as indicated by reset condition F in Figure 29-6. If a double bit fault is detected while reading the P-Flash phrase containing the Flash security byte during the reset sequence, all bits in the FSEC register will be set to leave the Flash module in a secured state with backdoor key access disabled.

Table 29-10. FSEC Field Descriptions

Field	Description
7–6 KEYEN[1:0]	Backdoor Key Security Enable Bits — The KEYEN[1:0] bits define the enabling of backdoor key access to the Flash module as shown in Table 29-11.
5–2 RNV[5:2]	Reserved Nonvolatile Bits — The RNV bits should remain in the erased state for future enhancements.
1–0 SEC[1:0]	Flash Security Bits — The SEC[1:0] bits define the security state of the MCU as shown in Table 29-12. If the Flash module is unsecured using backdoor key access, the SEC bits are forced to 10.

Table 29-11. Flash KEYEN States

KEYEN[1:0]	Status of Backdoor Key Access
00	DISABLED
01	DISABLED ⁽¹⁾
10	ENABLED
11	DISABLED

1. Preferred KEYEN state to disable backdoor key access.

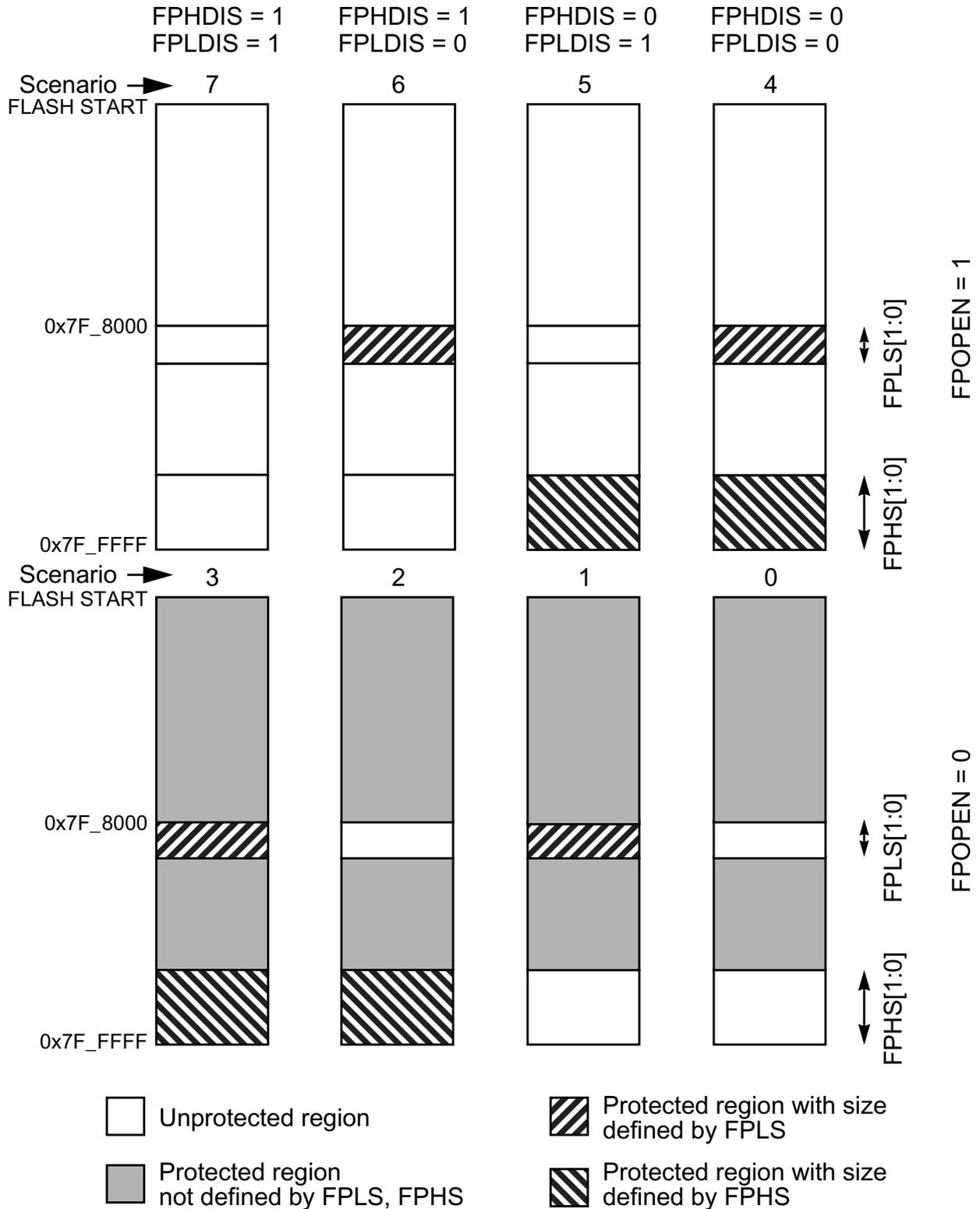


Figure 29-14. P-Flash Protection Scenarios